

microSD™ Card Connectors

DM3 Series



■ Features

◆ Common to the entire Series

1. Extremely small size

Small external dimensions and the above-the-board height make the connectors the smallest on the market.

2. Reverse card insertion protection

Unique card slot design (patented) protects the connector from damage when the card is attempted to be inserted in reverse, allowing it to re-inserted correctly.

3. Effective ground and shield configuration

4-connection points of the metal cover to the printed circuit board assures secure connection of the ground circuit and provides EMI protection.

4. Rigid and strong construction

Despite its small size, high-strength materials used in the connectors produced a strong and rigid structure.

5. Card detection switch

The card detection switch is Normally Open

◆ DM3AT and DM3BT (Push - Push, with ejection mechanism)

• Card fall-out prevention

Built-in card tray and the unique push insertion-push ejection mechanism (patented) prevent accidental card ejection or fall-out.

Despite its small size the connectors will eject the card to a distance of 4.0 mm, allowing easy hold and removal of the card.

• Exposed termination leads

Easy inspection and rework of the solder termination joints.

◆ DM3CS (Hinge, Push-Pull, manual, without ejection mechanism)

• Simple and reliable card insertion

Hinged metal cover provides location and guides the card during the insertion / removal. Closing of the cover confirms the electrical and mechanical connection with a tactile click sensation.

• Reliable contact with the card contact pads

Unique contact design and card slide action will clean the contact areas of the card.

• Accessible termination areas

Contact solder terminations may be inspected and reworked.



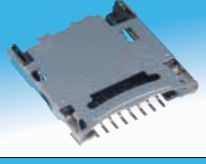
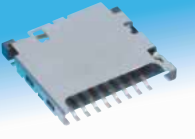
◆ DM3D (Push -Pull, manual, without ejection mechanism)

• Partial card insertion hold

Card will not fall-out even when it is not fully inserted. Full insertion and electrical / mechanical connection is confirmed with a distinct tactile feel.

• Accessible termination areas

An inner lead system that can be reworked is used in this design. Contact solder terminations may be inspected and reworked.

Card insertion-ejection	Series	Image	Page
Push-Push	DM3AT		2~4
	DM3BT		5~6
Hinge-manual insertion/ejection	DM3CS		7~8
Push-Pull manual insertion/ejection	DM3D		9~10

■Specifications(DM3 Series)

Ratings	Current rating: 0.5A Voltage rating: 125V AC	Operating temperature range: -25℃ to +85℃ (Note 1) Storage temperature range : -40℃ to +85℃ (Note 2)	Operating humidity range: RH 95% max. (No condensation)
Item	Specification	Conditions	
1. Insulation resistance	1000 MΩ min. (Initial value)	Measure at 500 V DC	
2. Withstanding voltage	No flashover or insulation breakdown	500 V AC / 1 minute	
3. Contact resistance	100mΩ max. (Initial value)	1mA	
4. Vibration	No electrical discontinuity of 100 ns or longer No damage, cracks or parts dislocation.	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 3 directions for 2 hours	
5. Humidity	Contact resistance: 40 mΩ max. (change from initial value) Insulation resistance: 100 MΩ min. No damage, cracks or parts dislocation.	96 hours at of 40 ± 2℃, and humidity of 90 to 95%	
6. Temperature cycle	Contact resistance: 40 mΩ max. (change from initial value) Insulation resistance: 100 MΩ min. No damage, cracks or parts dislocation.	-55℃ → 5 to 35℃ →+85℃ → 5 to 35℃ Times: 30 min. → 5 min. → 30 min. → 5 min. 5 cycles	
7. Durability	Contact resistance: 40 mΩ max. (change from initial value)	10,000 cycles, 400 to 600 cycles per hour (DM3AT, DM3B) 5,000 cycles, 400 to 600 cycles per hour (DM3C, DM3D)	
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow : At the recommended temperature profile Manual soldering : 350℃ for 3 seconds	

Note 1: Includes temperature rise caused by current flow.
Note 2. The term "storage" refers to products stored for long period prior to mounting and use.

■Materials and Finishes

DM3AT, DM3BT

Part	Material	Finish	Remarks
Insulator	LCP	Color: Black	UL94V-0
Contacts	Copper alloy	Contact area: Gold plated Lead area: Gold plated	_____
Guide cover	Stainless steel (DM3AT) Copper alloy (DM3BT)	Lead area: Gold plated	_____
Other components	Stainless steel (DM3AT, DM3BT) Piano wire (DM3BT)	_____ Nickel plated	_____

DM3CS, DM3D

Part	Material	Finish	Remarks
Insulator	LCP	Color: Black	UL94V-0
Contacts	Copper alloy	Contact area: Gold plated Lead area: Gold plated	_____
Guide cover	Stainless steel	Tin plated	_____

■Ordering information

DM3 AT – SF – PEJM5

① ② ③ ④

① Series name: DM3	③ Termination type : SF Right-angle SMT(Standard) DSF Right-angle SMT(Reverse)
② Connector type : AT Push-Push (ejection mechanism), Top board mounting (Standard) BT Push-Push (ejection mechanism), Bottom board mounting (Reverse) CS Hinge, Push-Pull (no ejection mechanism), Top board mounting (Standard) D Push-Pull (no ejection mechanism), Top board mounting (Standard) Number of contacts : 8	④ Card ejection code : PEJM5, PEJS (Push insert/push eject) None : Manual card insertion/ejection

Figure 1: Dimensions of the HS-M2 module. The diagram shows a top view of the module with various dimensions and labels. Key dimensions include: overall width 13.85 mm, pin pitch 1.68 mm, and pin width 0.8 mm. Pin labels include #1(DAT2), #2(CD/DAT3), #3(CMD), #4(VDD), #5(CLK), #6(VSS), #7(DAT0), and #8(DAT1). Other dimensions include 15.95 mm for the main body height, 16.75 mm for the card over stroke position, 17.55 mm for the card lock position, and 21.55 mm for the card eject position. A microSD card is shown inserted into the module. A note at the bottom right states "All dimensions: mm".

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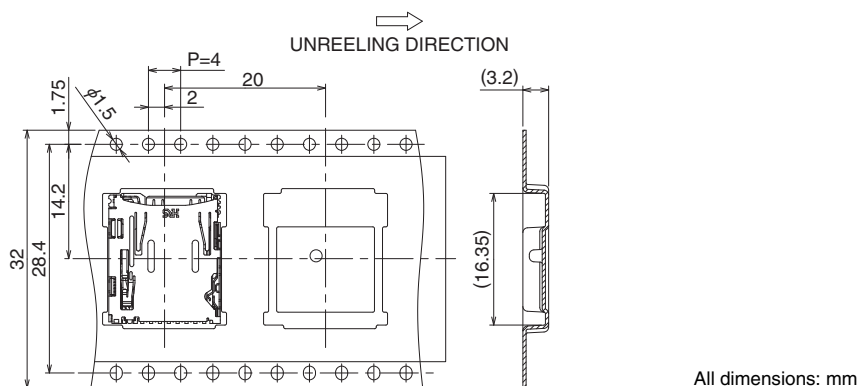
2

Card detection switch	
Without the card	Card inserted
<p>Open</p> <p>(A) (B)</p>	<p>Closed</p> <p>(A) (B)</p>

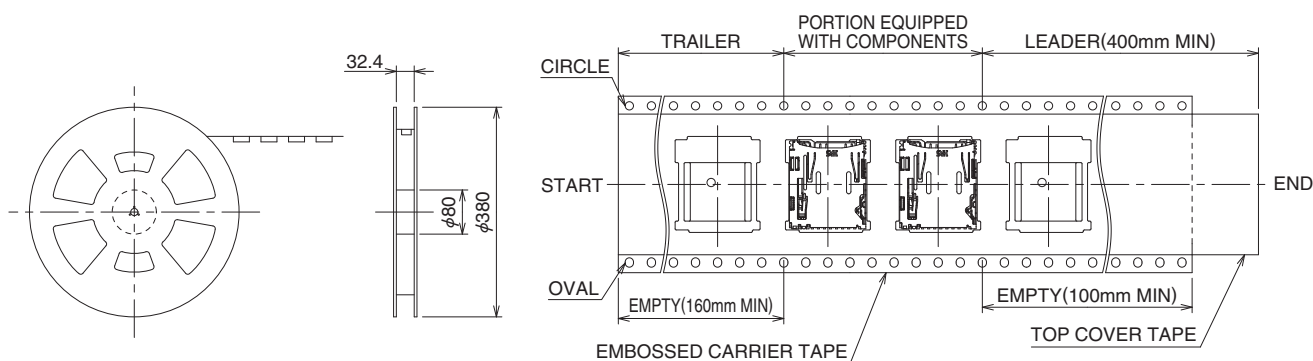
All dimensions: mm

■ Packaging Specifications

- Embossed carrier tape dimensions (1,500 pieces per reel)



- Reel Dimensions



Technical drawing of the HRS-01 module, showing top, side, and detail views with dimensions and pin labels.

Pin Labels (Top View):

- #4(VDD)
- #5(CLK)
- #3(CMD)
- #6(VSS)
- #2(CD/DAT3)
- #7(DAT0)
- #1(DAT2)
- #8(DAT1)

Dimensions (mm):

- Top View: 2.38MAX, 1.83, (3.2), 13.85, (6.5), 2.7MAX, 6.7MAX, 15.1, 15.45, (11), (5.5), 2.9±0.15
- Side View: (0.55), 2.38MAX, 1.83, (21.55), CARD EJECT POSITION, (17.55), CARD LOCK POSITION, (16.75), CARD OVER STROKE POSITION, 16.05, 15.95, (15)
- Detail View: (3)

Features:

- CARD DETECTION SWITCH(A)
- CARD DETECTION SWITCH(B)
- microSD CARD
- HRS

Notes:

- 1: \varnothing
- 2: (Arrow pointing to Card Detection Switches)
- 3: (Arrow pointing to Eject Pin)



Footer:


tern

All dimensions: mm

[illegible]

2

Card detection switch	
Without the card	Card inserted
<p>Open</p>  <p>(A) (B)</p>	<p>Closed</p>  <p>(A) (B)</p>

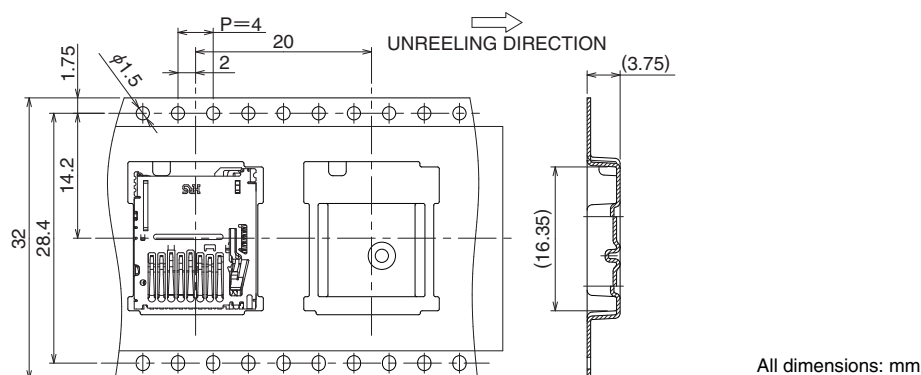
4  No conductive traces.

DM3BT-DSF-PEJS

Portable device

■ Packaging Specifications

- Embossed carrier tape dimensions (1,200pieces per reel)



- Reel Dimensions

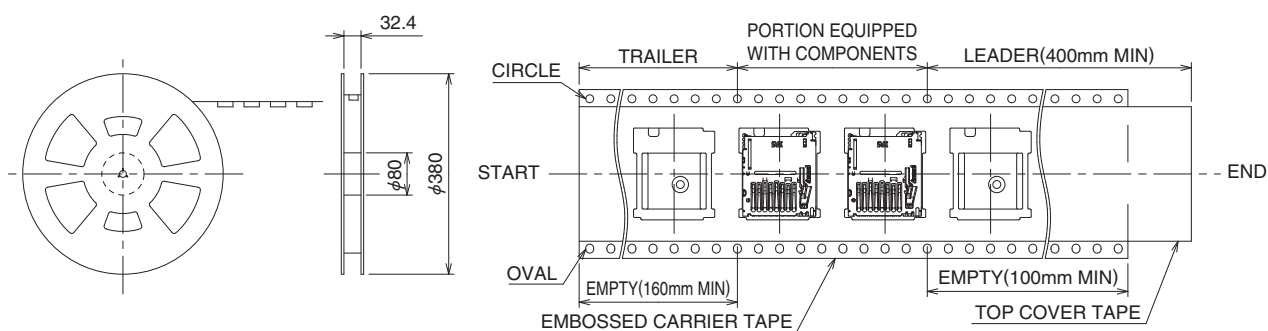


Figure 1: Dimensions of the module. The diagram shows three views of the module: top, front, and side. The top view shows a rectangular module with a width of 13.8 and a height of 13.9. It features a 'CARD DETECTION SWITCH' at the top, an 'OPEN' button with a downward arrow, and a 'LOCK' button with an upward arrow. The front view shows the module's profile with a height of 14.1 and a width of 13.9. The side view shows the module's profile with a height of 1.83 and a width of 0.1. The bottom view shows the module's pins, labeled #1(DAT2), #2(CD/DAT3), #3(CMD), #4(VDD), #5(CLK), #6(VSS), #7(DAT0), and #8(DAT1). The dimensions are in millimeters.

2

Card detection switch	
Without the card	Card inserted
<p>Open</p>	<p>Closed</p>

All dimensions: mm

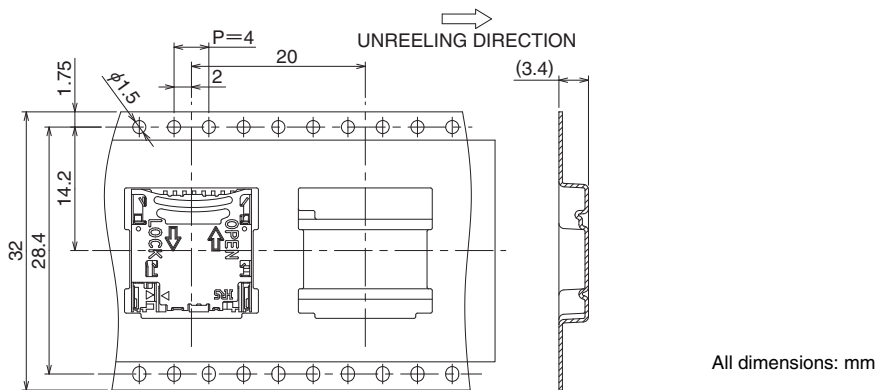
DM3CS-SF (shown open for card insertion)

DM3CS-SF (shown closed, with card inserted)

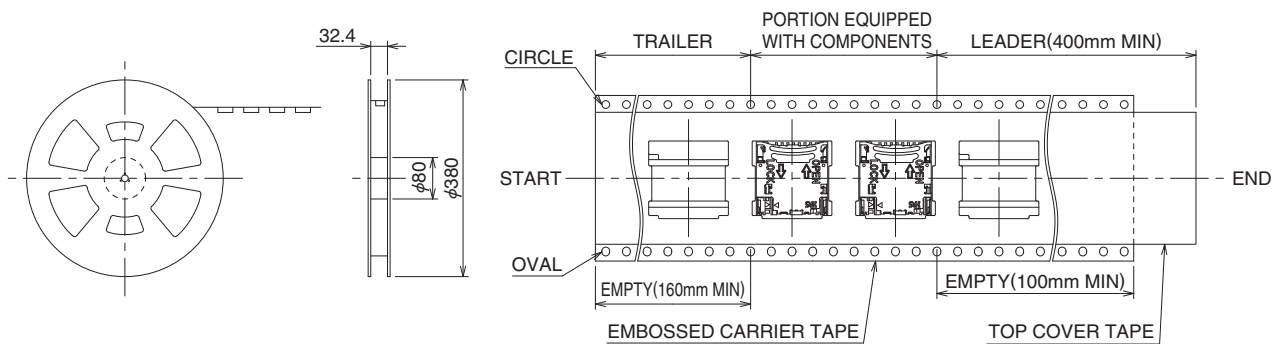
Portable device

■ Packaging Specifications

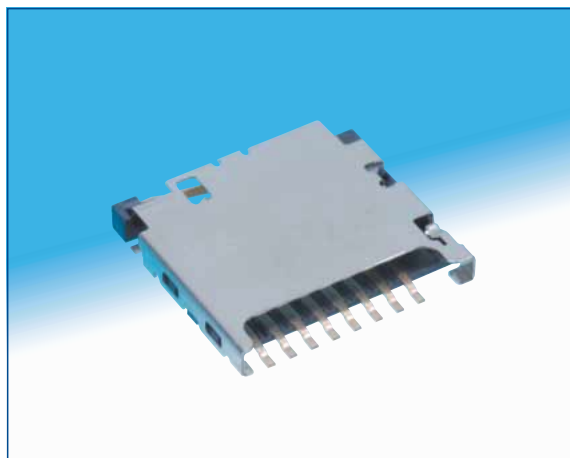
- Embossed carrier tape dimensions (1,300pieces per reel)



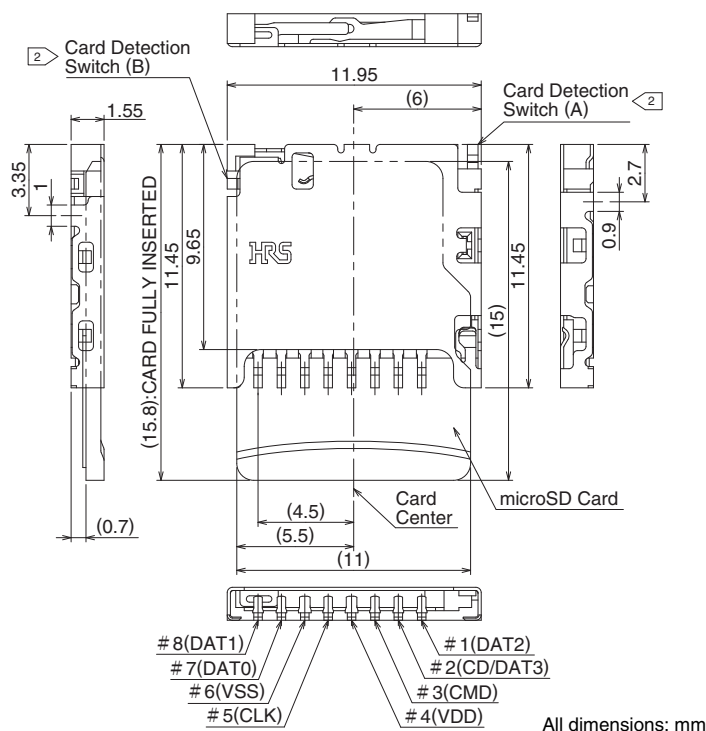
- Reel Dimensions



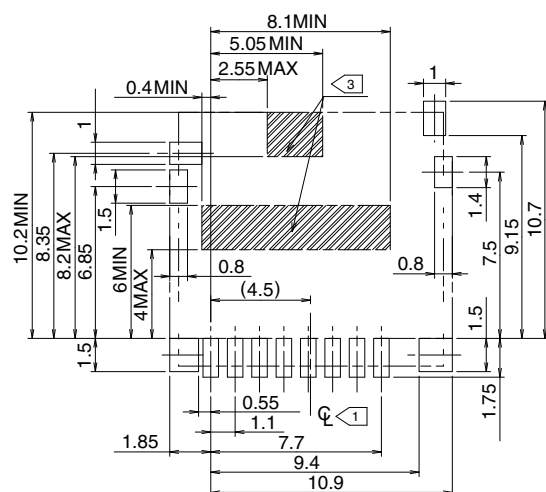
■DM3D, Push-Pull (no ejection mechanism), Top board mounting (Standard)



Part number	CL No.
DM3D-SF	609-0025-8



■Recommended PCB mounting pattern



Note 1 Φ indicates the center line of the microSD card slot.

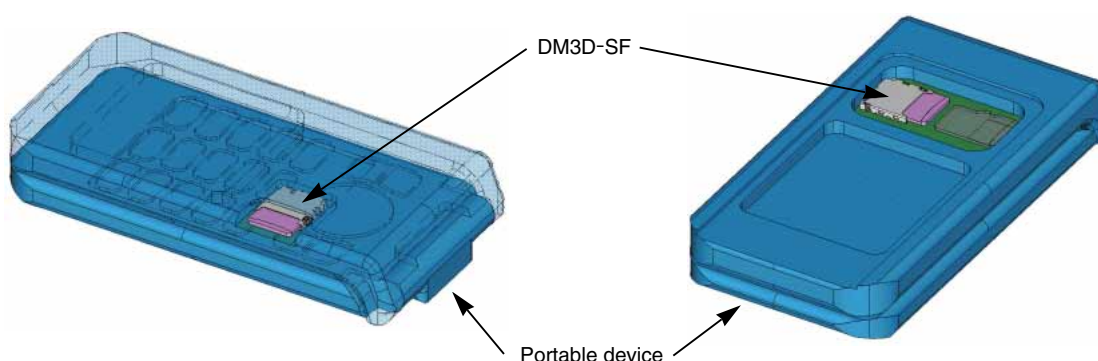
2

Card detection switch			
Without the card		Card inserted	
Open		Closed	
(A)	(B)	(A)	(B)

3 No conductive traces.

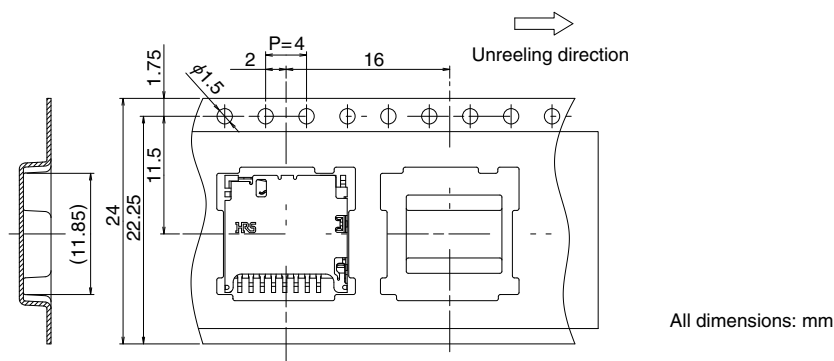
All dimensions: mm

● Example of applications

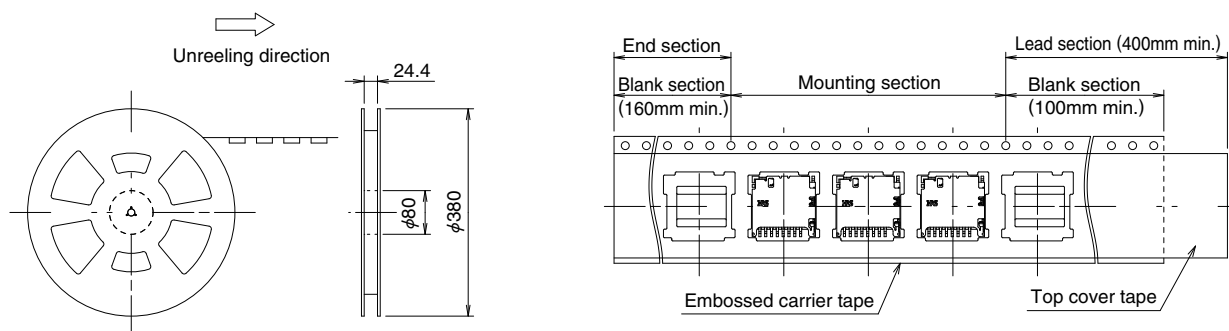


■ Packaging Specifications

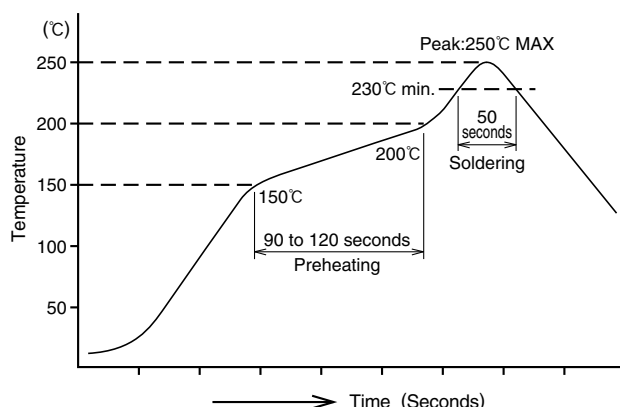
- Embossed carrier tape dimensions (2,000pieces per reel)



- Reel Dimensions



■ Recommended temperature profile



HRS test condition

Solder method :Reflow, IR/hot air
 Environment :Room air
 Solder composition :Paste, 96.5%Sn/3.0%Ag/0.5%Cu
 (Senju Metal Industry, Co., Ltd.'s
 Part Number:M705-GRN360-K2-V)
 Test board :Glass epoxy 60mm×100mm×1.0mm thick
 Metal mask :0.12mm thick
 Number of reflow cycles : 2cycles max.

The temperature profiles shown are based on the above conditions.

In individual applications the actual temperature may vary, depending on solder paste type, volume / thickness and board size / thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

■ Precautions

1. Do not immerse or clean the entire connector with cleaning solutions as this may affect proper operation of the ejection mechanism and electrical performance of the connector
2. Do not apply excessive force to the connector when handling or after installation on the PC board.
3. The connectors will reliably connect and operate with the correctly inserted microSD™ cards.
 Follow the correct insertion / ejection procedure for the specific connector in use.
 Attempts of incorrect insertion of the card may cause damage to the connector or the card.
4. The connector must be correctly mounted on the PC board before the card can be inserted. Do not insert the card in the un-mounted connector.
5. Mounting on the Flexible Printed Circuit (FPC)
 To assure correct performance it is recommended that a flat reinforcement plate 0.3 mm min. thick be used under the FPC.
6. Small visible residual manufacturing fluids or tooling marks do not affect connector's performance.
7. Repeated insertions and removal of the cards may leave some marks on the card itself. This will have no affect on the connector performance.

● Refer to applicable Operation Manual listed below for additional precautions.

Series	Operation Manual Number
DM3AT Series	ETAD-F0345
DM3BT Series	ETAD-F0324
DM3CS Series	ETAD-F0335
DM3D Series	ETAD-F0353

Mouser Electronics

Authorized Distributor

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[DM3AT-SF-PEJM5\(11\)](#) [DM3AT-SF-PEJM5\(42\)](#) [DM3AT-SF-PEJM5\(26\)](#) [DM3C-SF\(16\)](#) [DM3D-SF\(41\)](#) [DM3AT-SF-](#)
[PEJ2M5](#) [DM3AT-SF-PEJM5\(41\)](#)